2.4 - 2.5GHz

Features

- 2.4 2.5GHz Frequency Range
- Integrated PA, Bypass, Tx/Rx Switch
- Low TX Current for direct battery connection
- 18mA at +10dBm Output Power
- Up to 7dBm EDR Output Power
- Ultra-Low Bypass Current
- Bi-Directional Bypass with Low Insertion Loss
- 1-Bit Control between Bypass and PA Modes
- 2mm x 2mm x 0.45mm 8-Pin DFN Package
- -40°C to 105°C Temperature Range

Applications

- Bluetooth® Low Energy (BLE) Devices
- IoT (Internet of Things) / M2M Connectivity
- Bluetooth® Audio
- Bluetooth® Mesh Networks
- Sports and Medical Wearables
- Consumer Electronics, Toys
- Smart Home Appliances
- Remote Controllers Wireless Sensor Nodes
- Beacons
- Proximity Sensors
- Range Extenders

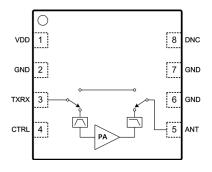


Figure 1: Functional Block Diagram

Description

The 8TR1219 is a compact, highly integrated front-end RFIC (Radio Frequency Integrated Circuit) intended for range extension of Bluetooth® Smart, 802.15.4 ZigBee™/ Thread, ANT+, and proprietary ISM wireless systems in the 2.4GHz band.

This application-friendly RFIC provides PA plus Bypass with Tx/Rx switches in an ultra-compact package. It requires only a dual-cell battery supply voltage and a single logic control signal.

The 8TR1219 combines a power amplifier (PA), bypass, and a transmit / receive (T/R) switch in a 2mm x 2mm x 0.45mm 8-pin DFN package. The device also comes integrated with filter networks, and input / output matching circuitry. This device is ideal for extended range BLE applications for Class 1 operation.

The 8TR1219 is RoHS compliant, halogen-free, and REACH Compliant. It is rated for Moisture Sensitivity Level 1 (MSL1), reflow at 260°C per JEDEC J-STD-020. Refer to IPC/JEDEC J-STD-020 for detailed solder reflow temperature and profile.



8-Lead 2mm x 2mm x 0.45mm, DFN Package

Figure 2: Package Type

Ordering Information

Part Number	Description
8TR1219	2.4GHz Front-End RFIC 2500 Pieces Per Tape and Reel
8TR1219-EVB	Fully Tested and Characterized Evaluation Board
8TR1219-DWF	2.4GHz Front-End RFIC Die in Wafer Form

2.4 - 2.5GHz

Pin Descriptions

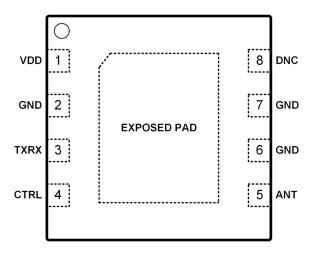


Figure 3:Pin Description (Top View)

Table 1: 8TR1219 Pin Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	VDD	DC Voltage Supply	5	ANT	Antenna port (DC shorted to GND)
2	GND	Ground	6	GND	Ground
3	TXRX	Transmit/Receive Port (DC shorted to GND)	7	GND	Ground
4	CTRL	Control Logic pin	8	DNC	Do Not Connect
EXPOSI	EXPOSED PAD Exposed pad should be connected to GND.				



2.4 - 2.5GHz

General Specifications

Table 2: 8TR1219 Absolute Maximum Ratings

Parameter	Units	Minimum	Maximum
Supply Voltage (VDD)	V	0	3.6
Control Logic Pin (CTRL)	V	0	VDD
Transmit Output Power at ANT Port	dBm		16
Transmit Input Power at TXRX Port	dBm		10
Bypass Mode Power at ANT or TXRX Port	dBm		15
Storage Temperature	°C	-40	150

Note: Sustained operation at or above the Absolute Maximum Ratings for any single or combinations of the above parameters may result in permanent damage to the device and is not recommended. All Maximum RF Input Power Ratings assume 50Ω terminal impedance.

Table 3: 8TR1219 Recommended Operating Conditions

Parameter	Units	Minimum	Typical	Maximum
Supply Voltage (VDD, recommended)	V	2.7	3.0	3.6
Supply Voltage (VDD, extend supply voltage)**	V	1.8		3.6
Control Pin - Logic High State	V	1.2		VDD*
Control Pin - Logic Low State	V	0		0.4
Control Pin Current (Logic High, 1.8V)	uA		0.2	
Operating Frequency Range	GHz	2.4		2.5
Operating Temperature	°C	-40	25	105

^{*}For Control Voltages > 3.0V, a 10k Ω series resistor should be used at the Control Logic Pins.

^{**}Functional working with degraded performance for the supply voltage range 1.8V to 2.7V.



2.4 - 2.5GHz

Table 4: 8TR1219 Transmit Electrical Specifications

(VDD = 3.0V, T_{Amblent}= 25°C, With External Harmonic Filter, Excluding PCB and Connector Loss, Unless Otherwise Noted)

Parameter	Units	Min	Тур	Max	Test Conditions	
Frequency Range	GHz	2.4		2.5		
Available Output Power	dBm		11			
EDR Spectral Mask	dBm		7		Spectral Mask compliant, 3Mbps EDR Signal	
Small-Signal Gain	dB		10		-30dBm Pin	
Large-Signal Gain	dB		10		+10dBm Pout	
Current Consumption	mA		18		+10dBm Pout	
Current Consumption	mA		8		No RF applied	
Second Harmonic	dBm/MHz		-50		Up to +10dBm with external	
Third Harmonic	dBm/MHz		-60		harmonic filter as specified	
Input Return Loss	dB		-20			
Load VSWR for Stability			6:1		All Non-harmonic Spurs Less than -43dBm/MHz	
Load VSWR for Ruggedness			10:1		No Damage	

Table 5: 8TR1219 Bi-Directional Bypass Electrical Specifications

(VDD = 3.0V, T_{Amblent}= 25°C, With External Harmonic Filter, Excluding PCB and Connector Loss, Unless Otherwise Noted)

Parameter	Units	Min	Тур	Max	Test Conditions
Frequency Range	GHz	2.4		2.5	
Bypass Current	uA		0.6		
Bypass Insertion Loss with Filter	dB		2.8		Between TXRX and ANT Ports

Table 6: 8TR1219 Switching Time Specifications

(VDD = 3.0V, T_{Ambient}= 25°C, With External Harmonic Filter, Unless Otherwise Noted)

Parameter	Units	Min	Тур	Max	Test Conditions
TX to Bypass	μsec		0.8		From 50% of CTRL to 10% RF
Bypass to TX	μsec		0.8		From 50% of CTRL to 90% RF

Table 7: 8TR1219 Control Logic

"1" = Logic High, "0" = Logic Low

CTRL	Operational Mode					
0	Bypass Mode*					
1	TX PA Mode					

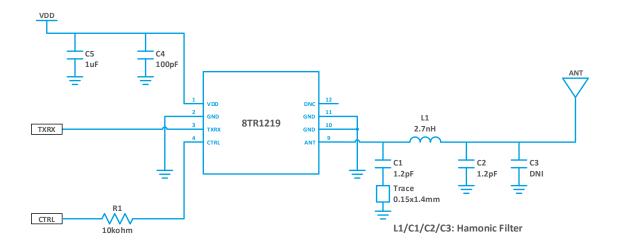
 $[\]hbox{* The Bypass Mode feature provides an ultra-low current consumption, as in a conventional sleep Mode.}$

2.4 - 2.5GHz

Application Notes

The 8TR1219 Application note provides detailed descriptions and test data over various operating conditions. Visit <u>www.berex.com</u> or contact BeRex at <u>sales@berex.com</u> to request additional documentation.

Application Schematic and PCB Layout



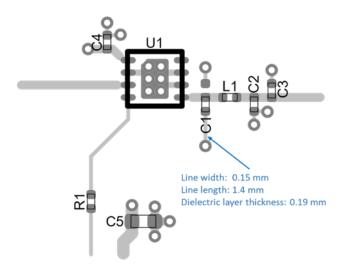


Figure 4: 8TR1219 Reference Design Schematic and PCB Layout

2.4 - 2.5GHz

Package Dimensions

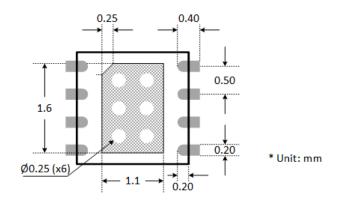
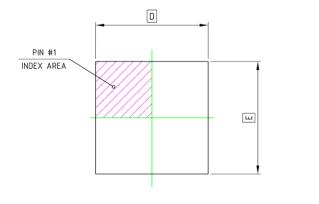
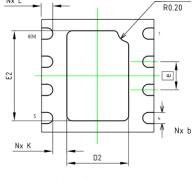


Figure 5: 8TR1219 Recommended PCB Layout Footprint



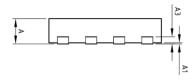


Pin #1 ID

TOP VIEW

	MIN.	NOM.	MAX.			
Α	0.41	0.45	0.50			
A1	0.00	0.02	0.05			
A3		0.127 Ref				
b	0.15	0.20	0.25			
D	2.00 BSC					
Е	2.00 BSC					
е	0.50 BSC					
D2	1.00	1.10	1.20			
E2	1.50	1.60	1.70			
K	0.20					
Ĺ	0.10 0.20 0.30					
N	8					

BOTTOM VIEW

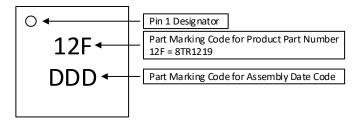


SIDE VIEW

Figure 6: 8TR1219 Package Dimension

2.4 - 2.5GHz

Package Marking



Note: The part marking: 12E represents the Product Part Number: 8TR1219.

Due to the size limitations of this package, only three (3) characters can be marked on each of two (2) rows.

Therefore the Product Part Number is represented in the part marking by a 3-character code.

Figure 7: 8TR1219 Typical Part Marking

ESD Handling Information

Electro Static Discharge (ESD) can cause immediate (or latent) failures in semiconductor Integrated Circuits (ICs). BeRex, Inc. RFIC products are designed with integral ESD protection structures, and all IC products are tested to meet industry standards for ESD event survival. Users must adhere to all precautions for handling ESD sensitive devices throughout the manufacturing, test, shipping, handling, or operational processes, and during field service operations in order to achieve optimum system performance and life expectancy. Production quantities of this product are shipped in a standard tape and reel format. Electrostatic Discharge Rating - 3000V

RoHS Compliance 📵 🌋 📵







This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This part is lead-free, halogen-free and compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each component of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

2.4 - 2.5GHz

Tape & Reel

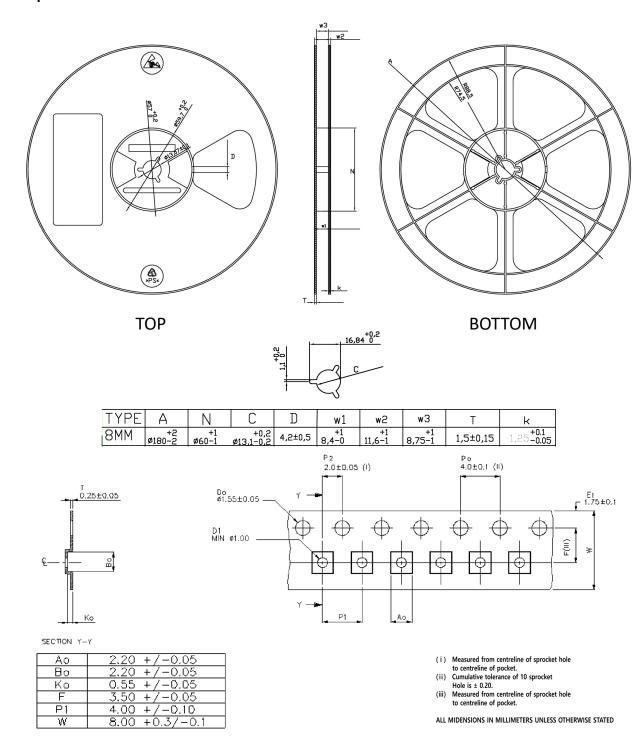


Figure 8: 8TR1219 Tape and Reel Dimension